

# Quantitative scanning thermal microscopy studies of the influence of interfaces and heat transport anisotropy in 2D materials

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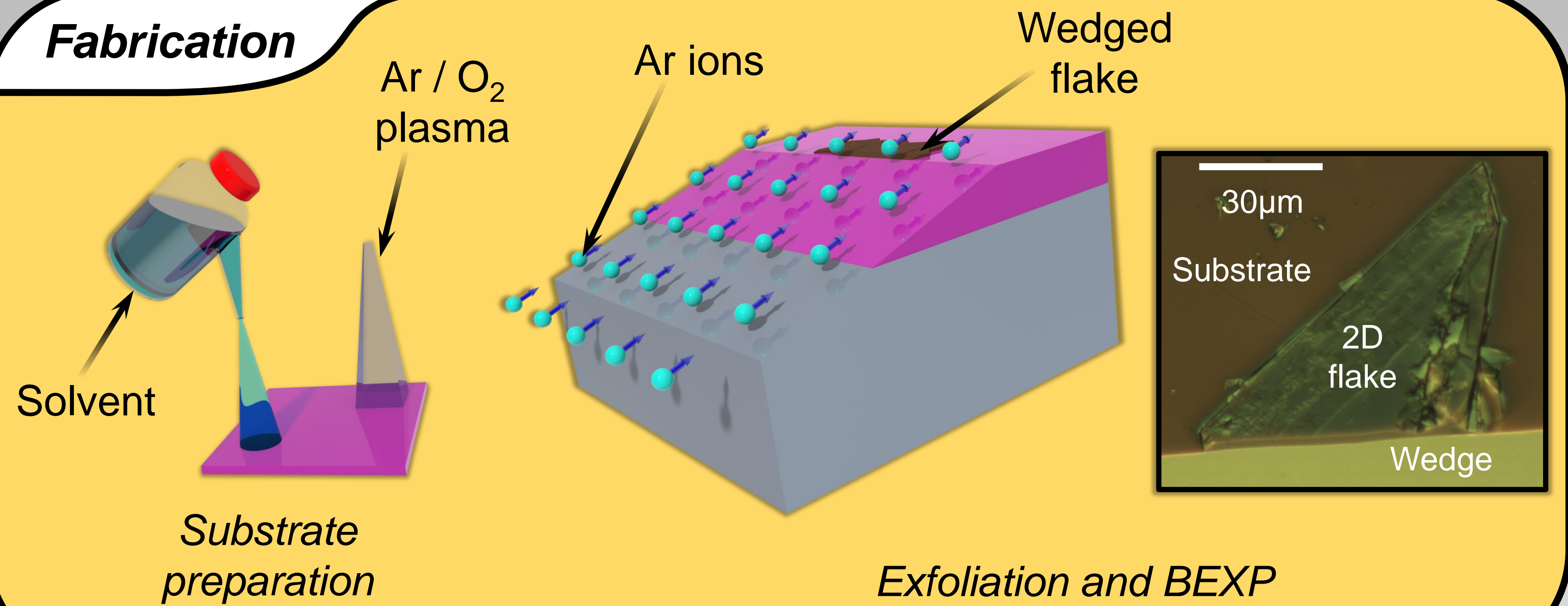
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## Introduction

- ? Intrinsic *anisotropy* in bi-dimensional materials.<sup>1</sup>
- ? *Interface* / substrate role in the heat transport.<sup>2</sup>
- ? True *nanoscale resolution* of thermal properties depending on thickness.<sup>3</sup>

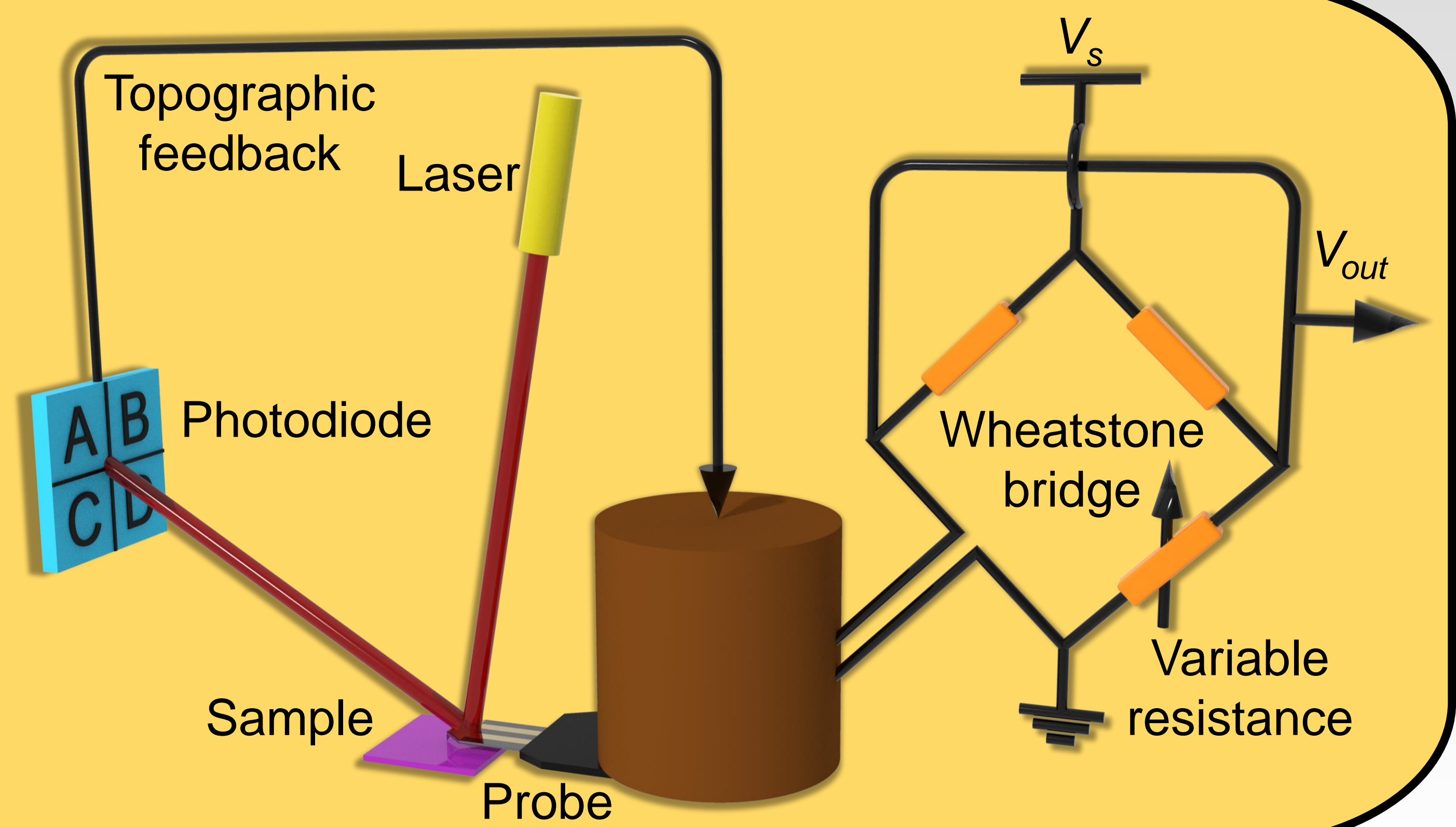
- Thermal transport in anisotropic graphene,  $\gamma$ -InSe, and perovskite.
- Interface effects on Si and SiO<sub>2</sub> substrates.
- Quantification of anisotropic thermal conductivities and interfacial thermal resistivity.

## Fabrication

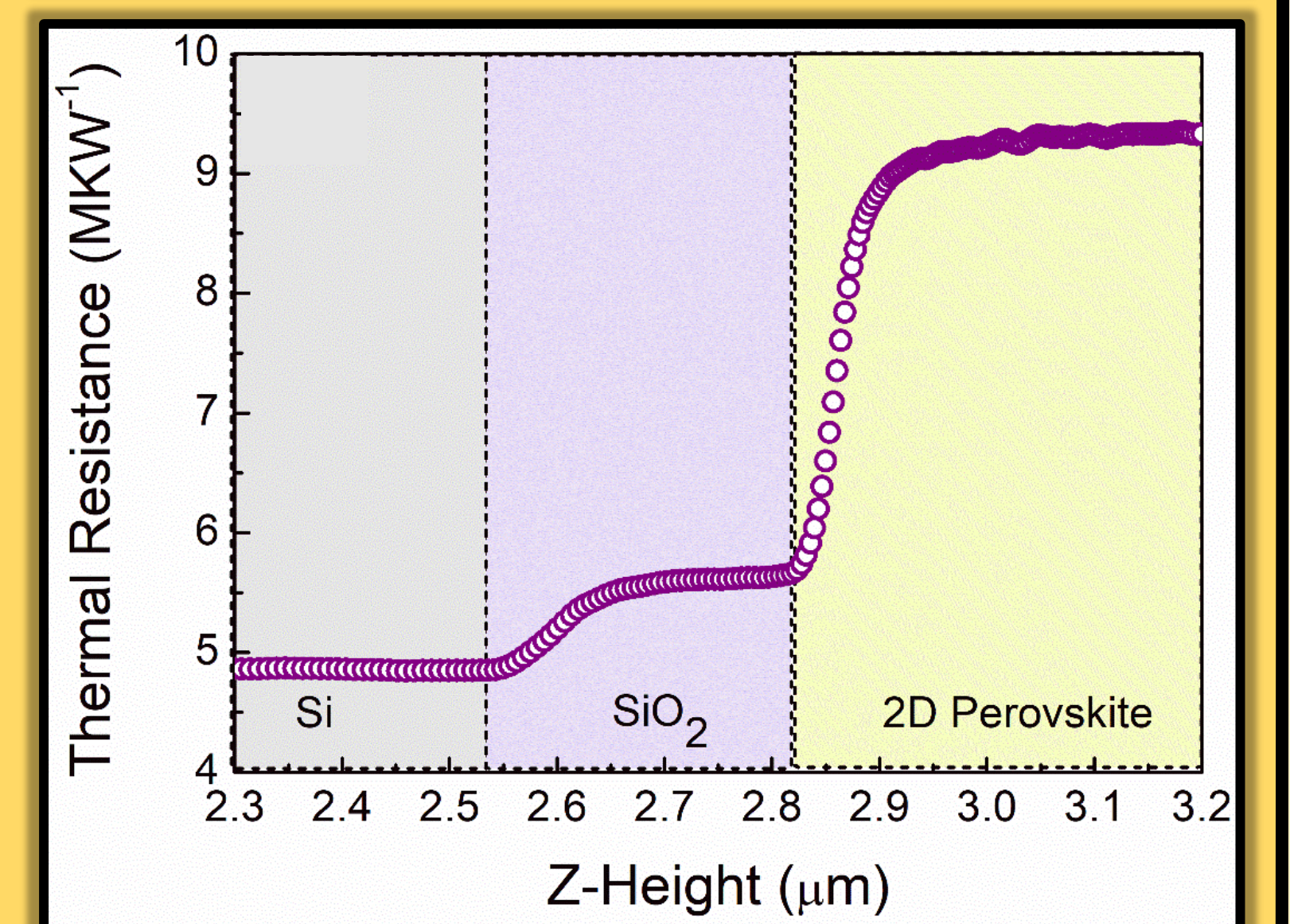
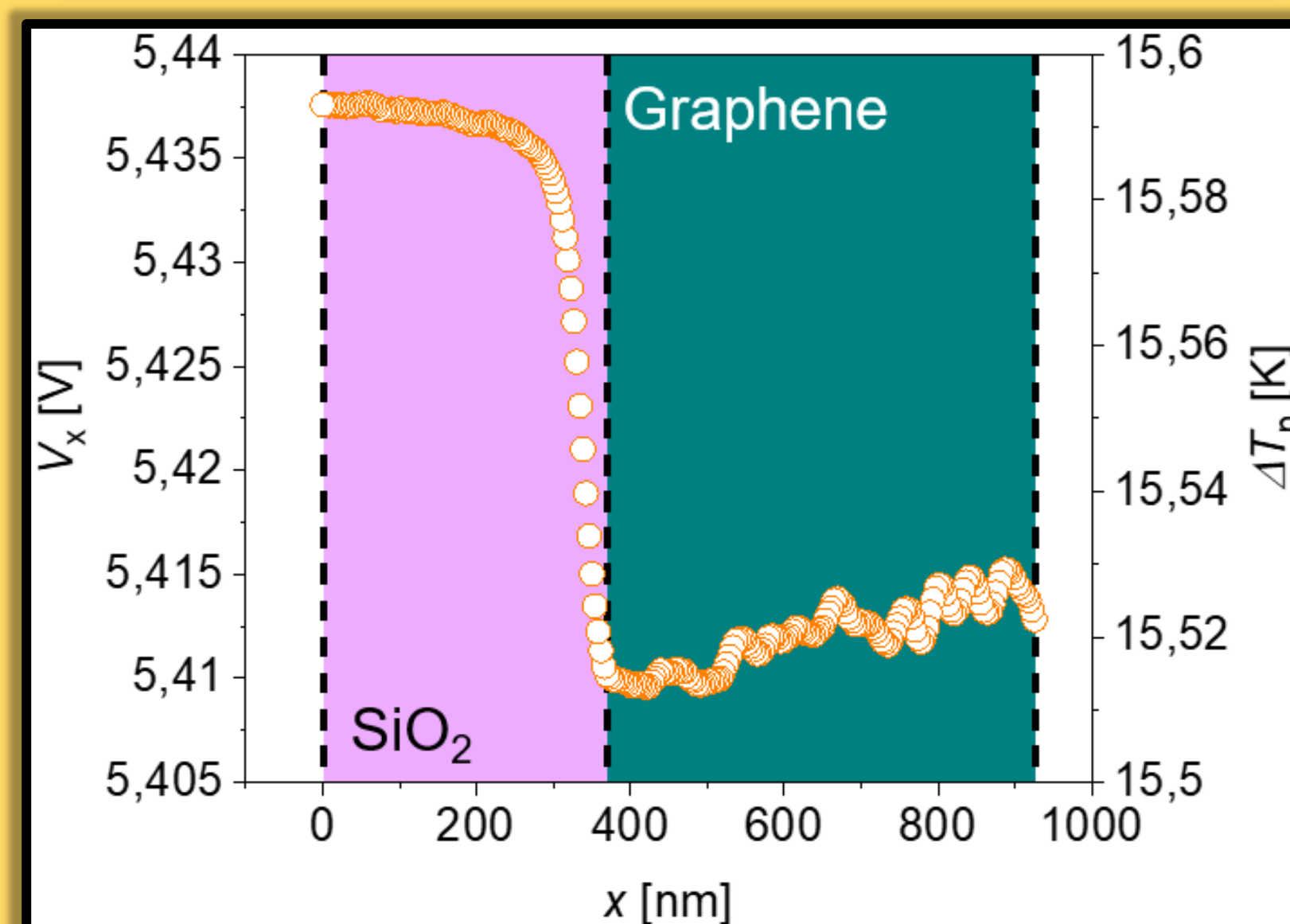
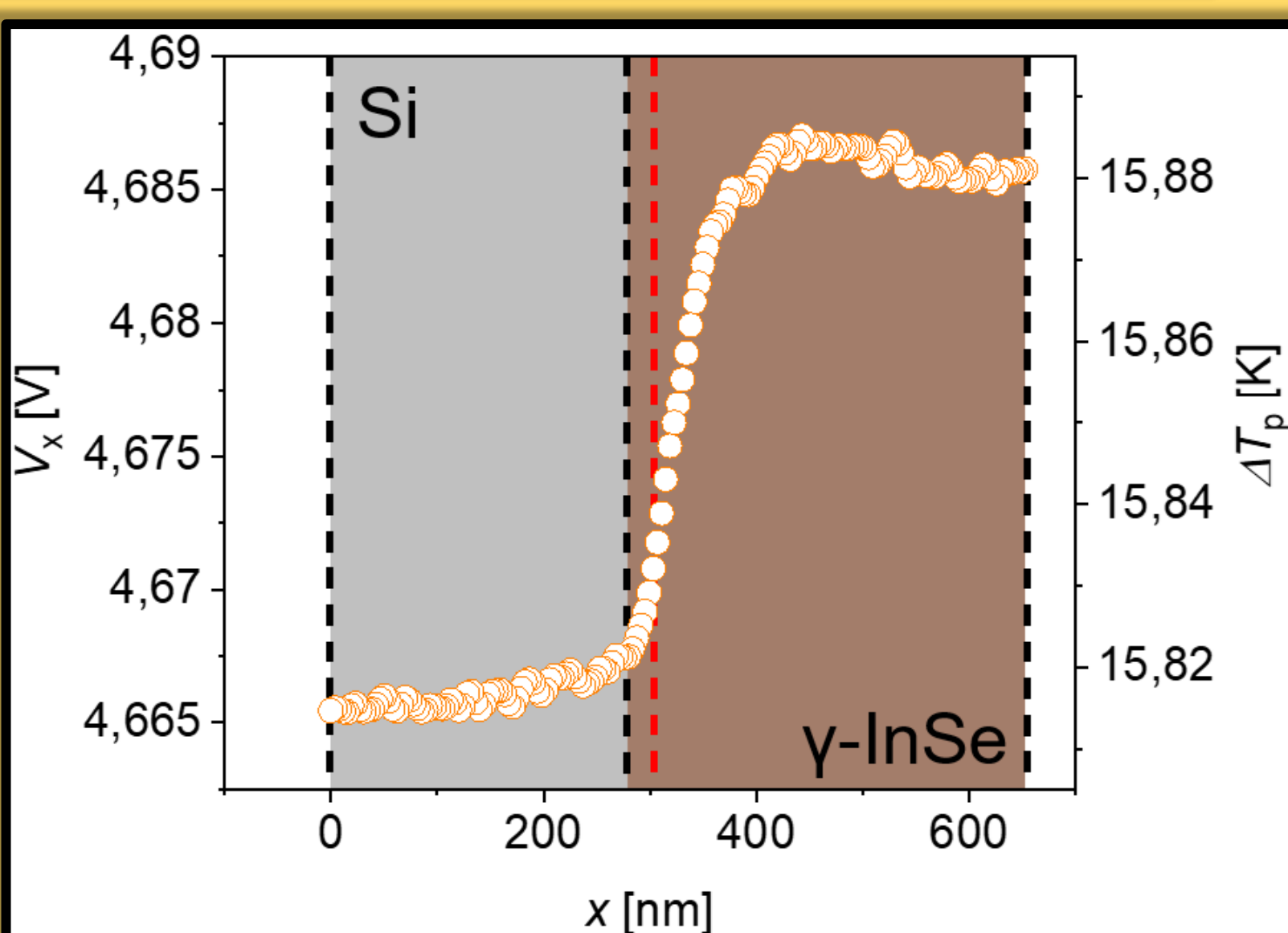
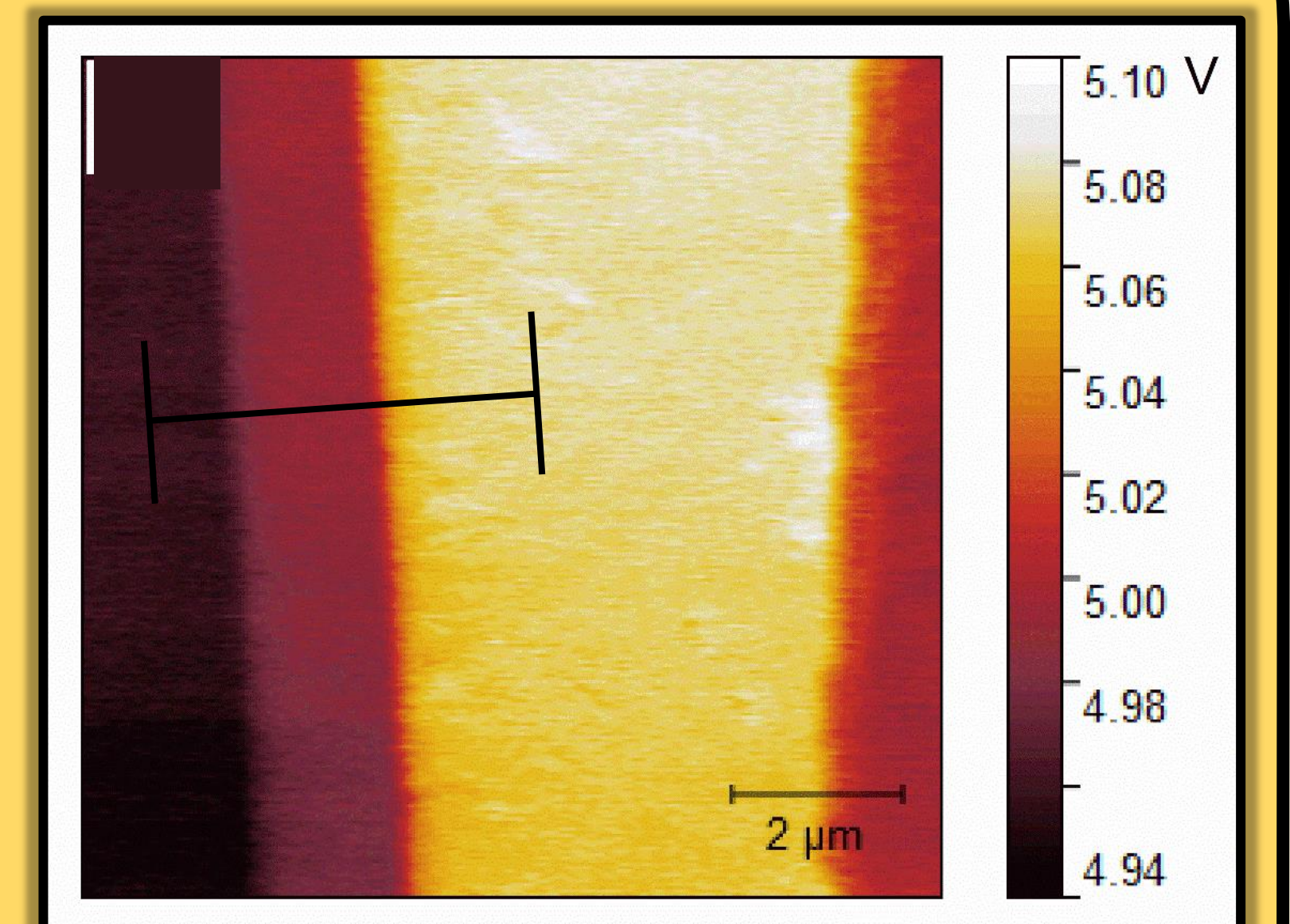
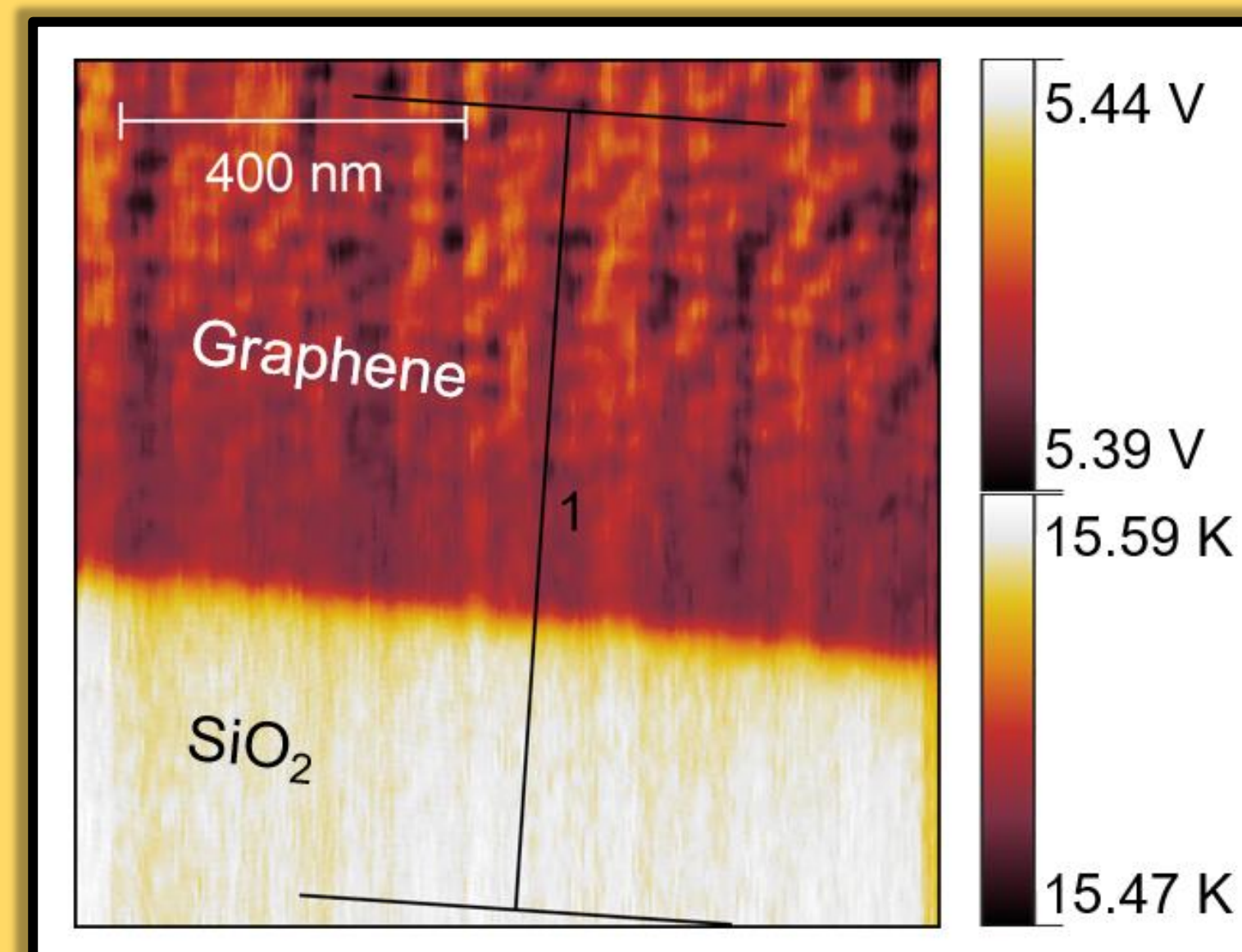
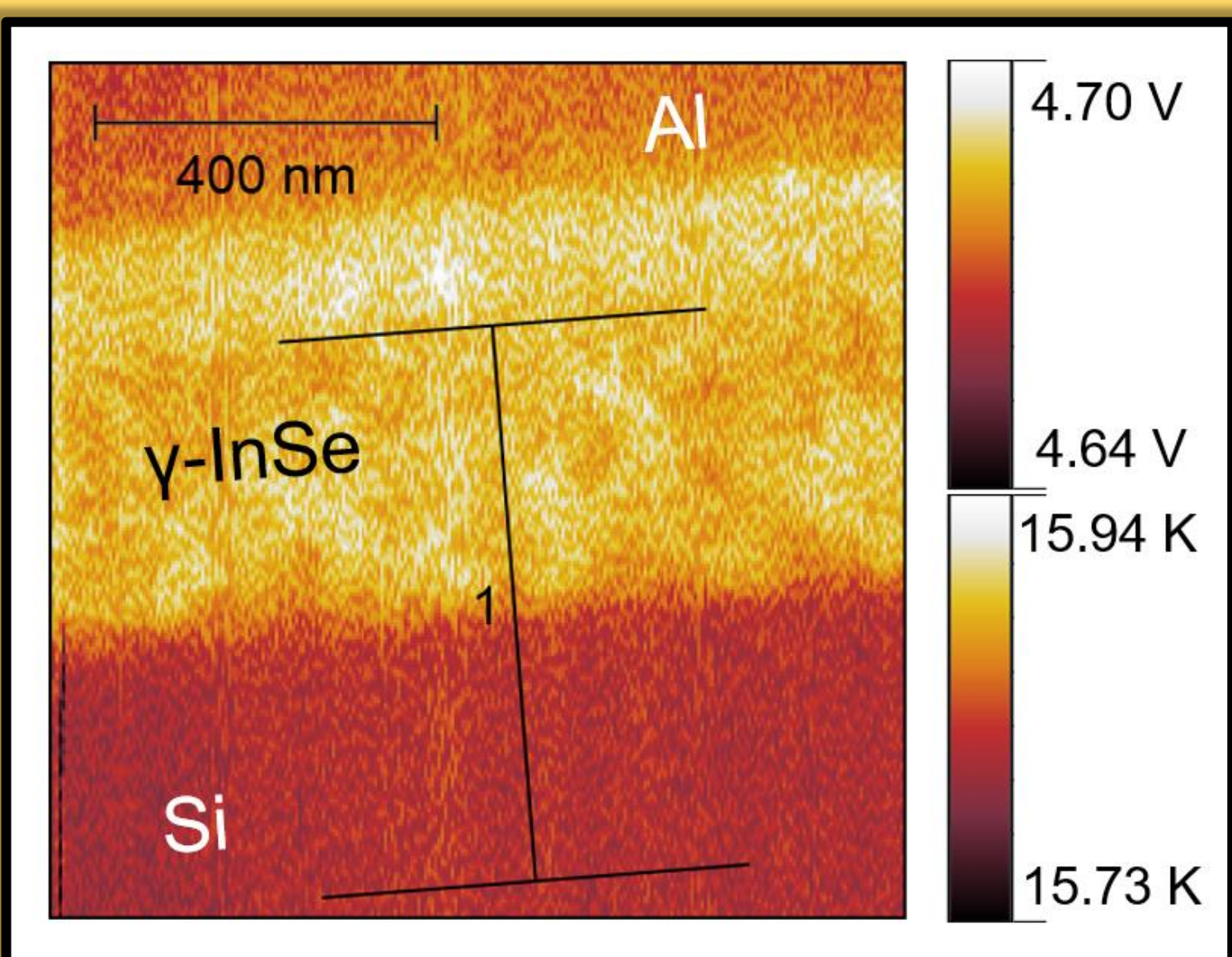


## Characterization

- HV-SThM (see right scheme) performed under high vacuum conditions and room temperature.
- SThM's probe incorporates a resistive heater receiving constant power via a DC-AC Wheatstone bridge.
- $V_{out} \propto T_{probe} \rightarrow T_{probe}$  changes due to variations of the probe-sample heat flow.
- By moving the probe across the sample surface, a quantitative map of the sample heat transport is obtained.<sup>4</sup>



## Results



Materials	$a$ [nm]	$r_{int}$ [Km <sup>2</sup> W <sup>-1</sup> ]	$k_{xy}$ [Wm <sup>-1</sup> K <sup>-1</sup> ]	$k_z$ [Wm <sup>-1</sup> K <sup>-1</sup> ]
$\gamma$ -InSe/Si	22.92	$9.60 \times 10^{-11}$	2.16	0.89
Perovskite /SiO <sub>2</sub>	55	$100 \times 10^{-11}$	0.45	0.13

- ✓  $r_{int}$  affects heat transport up to a limit, then it becomes negligible.
- ✓ Record-low anisotropic  $k$  for novel TE devices.
- ✓ True nanoscale resolution of heat transport features.

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## References

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